

(3) To strengthen ties with Shanghai Jiao Tong University.

(4) To build business relations in China.

Background:

Starting four years ago, Mori Seiki developed a relationship with the leader in Chinese die and mold machining, Professor Xueyu Ruan (Academician, Chinese Academy of Engineering, Director of the Department of Plasticity Technology and Director of the National Die & Mold CAD Engineering Research Center at Shanghai Jiao Tong University), and from that relationship developed a relationship with the university, where the Center was established, and to which Mori Seiki has decided to donate two machine tools for the purpose of cutting in die and mold machining. Mori Seiki will in the future send engineers on a regular basis to provide research assistance and help in applying research results. Bi-monthly seminars are also planned with guest lecturers. Joint research on software has already begun at the university. In addition to the Shanghai Technical Center, Mori Seiki has opened Technical Centers in Beijing, Tianjin, Dalian, Shenzhen, Dongguang, and is working to develop business in China. By strengthening its relationship with the university, Mori Seiki will continue to pursue further business development in China.